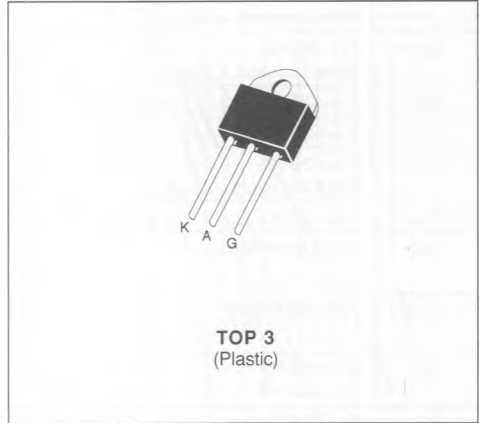




THYRISTORS

- GLASS PASSIVATED CHIP
- HIGH STABILITY AND RELIABILITY
- HIGH SURGE CAPABILITY
- EASY MOUNTING ON HEATSINK



DESCRIPTION

General purpose SCR suited for power supplies up to 400 Hz on resistive or inductive loads.

ABSOLUTE RATINGS (limiting values)

| Symbol | Parameter | | BTW68-200N → 800N | BTW68-1000N/1200N | Unit |
|--------------------|---|----------------------------------|-------------------|--------------------------|------------------------|
| | | | $I_{T(RMS)}$ | RMS on-state Current (1) | |
| $I_{T(AV)}$ | Mean on-state Current (1) | $T_c = 75\text{ }^\circ\text{C}$ | 22 | | A |
| I_{TSM} | Non Repetitive Surge Peak on-state Current (T_j initial = $25\text{ }^\circ\text{C}$) (2) | $t = 8.3\text{ ms}$ | 420 | 315 | A |
| | | $t = 10\text{ ms}$ | 400 | 300 | |
| i^2t | i^2t Value for Fusing | $t = 10\text{ ms}$ | 800 | 450 | A^2s |
| di/dt | Critical Rate of Rise of on-state Current (3) | | 100 | | $\text{A}/\mu\text{s}$ |
| T_{stg} T_j | Storage and Operating Junction Temperature Range | | - 40 to 125 | | $^\circ\text{C}$ |
| | | | - 40 to 125 | | $^\circ\text{C}$ |

| Symbol | Parameter | BTW68- | | | | | | Unit |
|------------------------|---------------------------------------|--------|------|------|------|-------|-------|------|
| | | 200N | 400N | 600N | 800N | 1000N | 1200N | |
| V_{DRM} V_{RRM} | Repetitive Peak off-state Voltage (4) | 200 | 400 | 600 | 800 | 1000 | 1200 | V |

(1) Single phase circuit, 180° conduction angle.

(2) Half sine wave.

(3) $I_G = 500\text{ mA}$ $di_G/dt = 1\text{ A}/\mu\text{s}$.

(4) $T_j = 125\text{ }^\circ\text{C}$.

THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|---------------|----------------------------|-------|---------------------------|
| $R_{th(j-c)}$ | Junction-case for D.C. | 1.1 | $^\circ\text{C}/\text{W}$ |
| $R_{th(c-h)}$ | Contact (case to heatsink) | 0.20 | $^\circ\text{C}/\text{W}$ |

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 50 \text{ W}$ ($t_p = 10 \mu\text{s}$)

$I_{FGM} = 2 \text{ A}$ ($t_p = 10 \mu\text{s}$)

$V_{RGM} = 5 \text{ V}$

$P_{G(AV)} = 1 \text{ W}$

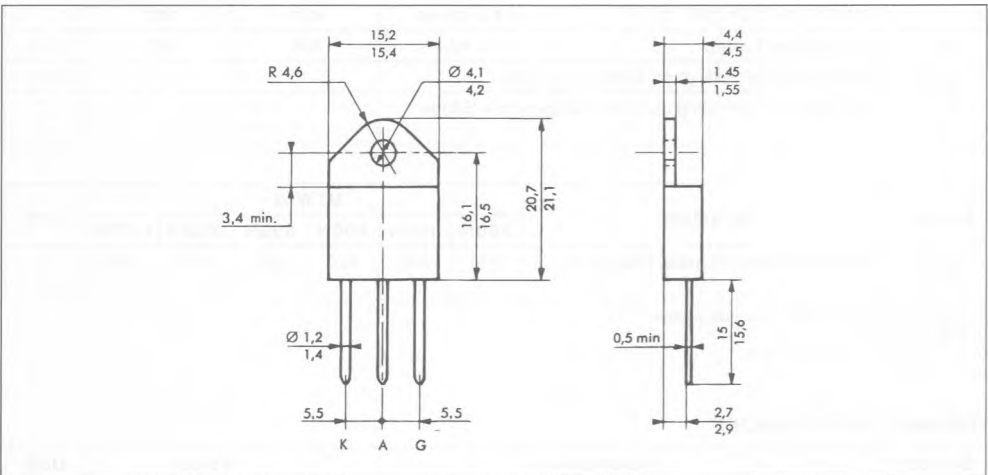
$V_{FGM} = 15 \text{ V}$ ($t_p = 10 \mu\text{s}$)

ELECTRICAL CHARACTERISTICS

| Symbol | Test Conditions | | Min. | Typ. | Max. | Unit |
|-----------|--|--|------------------------------------|------|------|------------------------|
| I_{GT} | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ | | | 50 | mA |
| V_{GT} | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ | | | 1.5 | V |
| V_{GD} | $T_j = 125 \text{ }^\circ\text{C}$ | $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ | 0.2 | | | V |
| I_H | $T_j = 25 \text{ }^\circ\text{C}$ | $I_T = 0.5 \text{ A}$ Gate Open | | 20 | 75 | mA |
| I_L | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ $I_G = 100 \text{ mA}$ | | 40 | | mA |
| V_{TM} | $T_j = 25 \text{ }^\circ\text{C}$ | $I_{TM} = 70 \text{ A}$ $t_p = 10 \text{ ms}$ | | | 2.25 | V |
| I_{DRM} | V_{DRM} Specified | | $T_j = 25 \text{ }^\circ\text{C}$ | | 0.02 | mA |
| | | | $T_j = 125 \text{ }^\circ\text{C}$ | | 3 | |
| I_{RRM} | V_{RRM} Specified | | $T_j = 25 \text{ }^\circ\text{C}$ | | 0.02 | mA |
| | | | $T_j = 125 \text{ }^\circ\text{C}$ | | 3 | |
| t_{gt} | $T_j = 25 \text{ }^\circ\text{C}$ $I_G = 200 \text{ mA}$ | $V_D = V_{DRM}$ $di_G/dt = 0.2 \text{ A}/\mu\text{s}$ | | 2 | | μs |
| t_q | $T_j = 125 \text{ }^\circ\text{C}$ $V_D = 67 \% V_{DRM}$ Gate Open | $I_T = 70 \text{ A}$ $di/dt = 30 \text{ A}/\mu\text{s}$ | | 100 | | μs |
| dv/dt^* | $T_j = 125 \text{ }^\circ\text{C}$ Linear Slope up to $V_D = 67 \% V_{DRM}$ | Gate Open | $V_{DRM} \leq 800 \text{ V}$ | 500 | | $\text{V}/\mu\text{s}$ |
| | | | $V_{DRM} \geq 1000 \text{ V}$ | 250 | | |

* For higher guaranteed values, please consult us

PACKAGE MECHANICAL DATA : TOP 3 Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 5 g

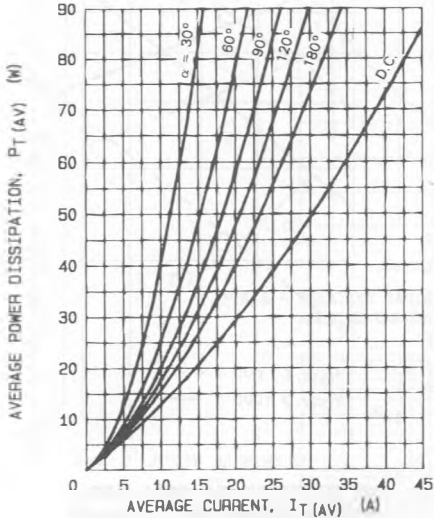
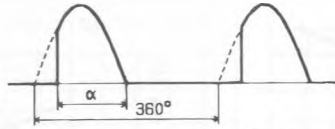


FIG.1 - MAXIMUM ON-STATE POWER DISSIPATION FOR SINUSOIDAL CURRENT WAVEFORM

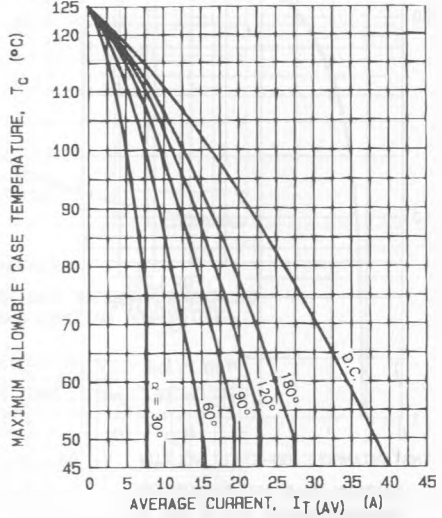


FIG.2 - MAXIMUM ALLOWABLE CASE TEMPERATURE FOR SINUSOIDAL CURRENT WAVEFORM

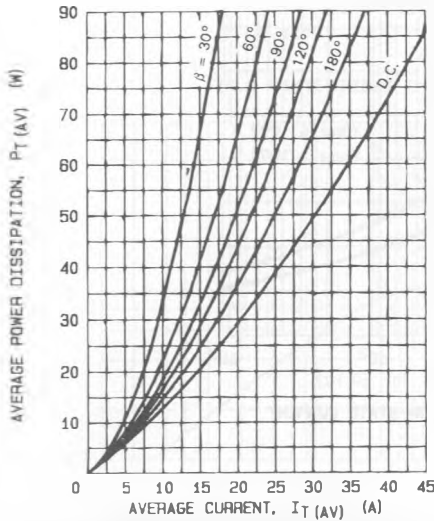


FIG.3 - MAXIMUM ON-STATE POWER DISSIPATION FOR RECTANGULAR CURRENT WAVEFORM

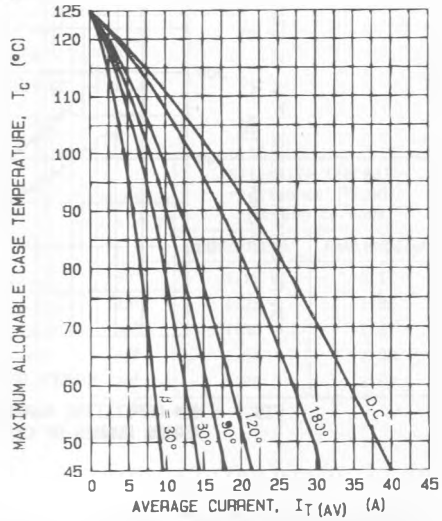


FIG.4 - MAXIMUM ALLOWABLE CASE TEMPERATURE FOR RECTANGULAR CURRENT WAVEFORM

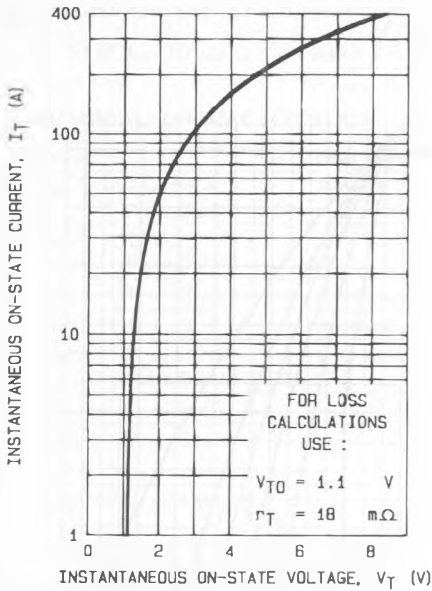


FIG. 5 - MAXIMUM ON-STATE CONDUCTION CHARACTERISTIC ($T_J = 125^\circ\text{C}$).

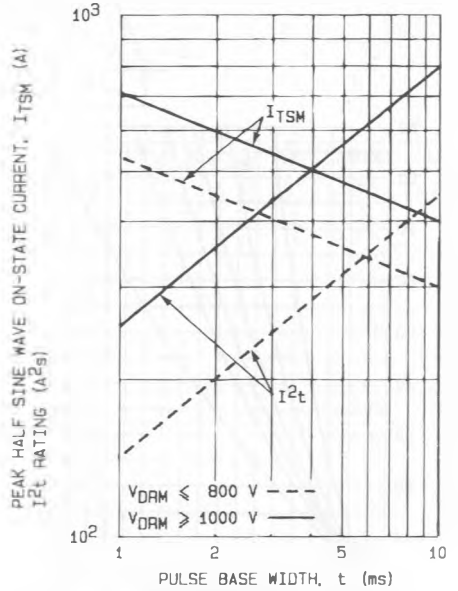


FIG. 8 - NON REPETITIVE SUB-CYCLE SURGE ON-STATE CURRENT AND I^2t RATINGS (INITIAL $T_J = 25^\circ\text{C}$).

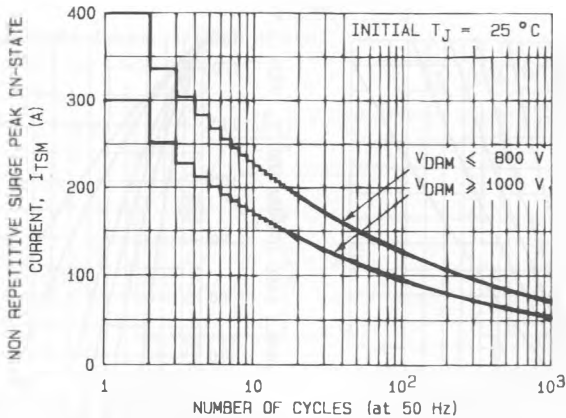


FIG. 7 - NON REPETITIVE SURGE PEAK ON-STATE CURRENT VERSUS NUMBER OF CYCLES.

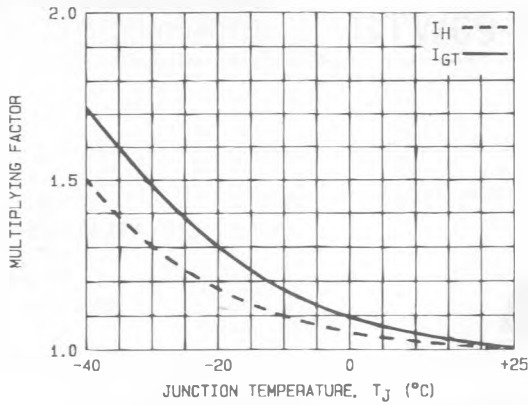


FIG.8 - RELATIVE VARIATION OF GATE TRIGGER CURRENT AND HOLDING CURRENT VERSUS JUNCTION TEMPERATURE.

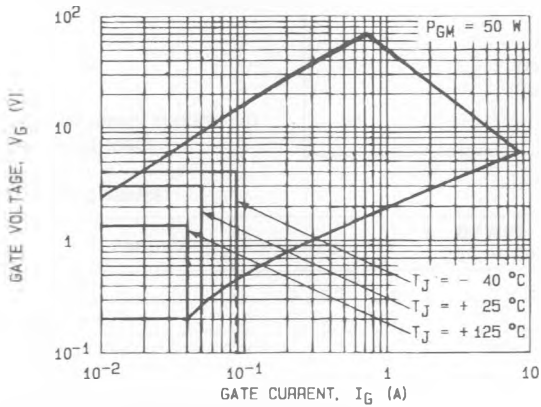
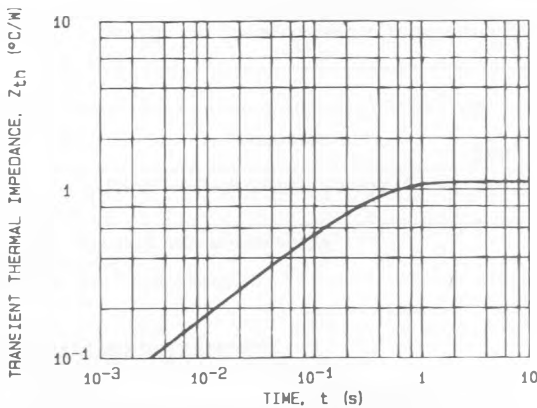


FIG.9 - GATE TRIGGER CHARACTERISTICS.



| Conduction angle (α, β) | Effective thermal resistance ($^{\circ}\text{C}/\text{W}$) junction to case | |
|--------------------------------------|---|-------------|
| | Sinusoidal | Rectangular |
| 180° | 1.19 | 1.17 |
| 120° | 1.23 | 1.65 |
| 90° | 1.32 | 1.87 |
| 60° | 1.54 | 2.09 |
| 30° | 1.98 | 2.64 |

FIG.10 - TRANSIENT THERMAL IMPEDANCE JUNCTION TO CASE.